Resistive Product Solutions

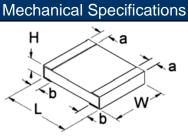
Features:

- R Value extension of RMCF product
- Highly stable performance over time
- Power derating from 100% at 70°C to zero at 125°C
- E12 and E24 values
- Nickel barrier terminations
- RoHS compliant and halogen free



Electrical Specifications							
Type/Code	Power Rating (W) @ 70°C	Maximum Working	Maximum Overload	TCR (ppm/⁰C)			
	()	Voltage (V) (1)	Voltage (V)		1%	5%	10%
HMC0402	0.063	50	100	± 200	11 M - 20 M -		
	0.000			± 400		22 M - 100 M	
				± 200	11 M - 20 M	-	
HMC0603	0.1	50	100	± 400	22 M - 100 M		
				± 500	-	110 M	- 1 G
				± 200	11 M - 20 M	-	
	0.125	150		± 400	22 M - 100 M		
HMC0805			300	± 500	-	110 M - 500 M	
				± 1000	-	510 M - 1 G	
				± 1500	-	1.2 G - 10 G	
				± 200	11 M - 20 M	-	
	0.25	200	400	± 400	22 M - 100 M	30 M - 100 M	
HMC1206				± 500	-	110 M - 500 M	
				± 1000	-	510 M	- 1 G
				± 1500	-	1.2 G -	10 G
	0.00	000	400	± 200	11 M - 20 M	-	11 M - 20 M
HMC1210	0.33	200	400	± 400		22 M - 100 M	
	0.75			± 200	11 M - 20 M		
HMC2010	0.75	200	400	± 400		22 M - 100 M	
	4	1 250 500	± 200	11 M - 20 M			
HMC2512	1		500	± 400		22 M - 100 M	

(1) Lesser of \sqrt{PR} or maximum working voltage.



Type/Code	L	W	Н	а	b	Unit
Type/Code	Body Length	Body Width	Body Height	Top Termination	Bottom Termination	Onit
HMC0402	0.039 ± 0.002	0.020 ± 0.002	0.014 ± 0.002	0.008 ± 0.004	0.008 ± 0.004	inches
FINC0402	1.00 ± 0.05	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.20 ± 0.10	mm
HMC0603	0.063 ± 0.004	0.031 ± 0.004	0.018 ± 0.004	0.012 ± 0.008	0.012 ± 0.008	inches
	1.60 ± 0.10	0.80 ± 0.10	0.45 ± 0.10	0.30 ± 0.20	0.30 ± 0.20	mm
HMC0805	0.079 ± 0.008	0.049 ± 0.004	0.020 ± 0.004	0.016 ± 0.008	0.016 ± 0.008	inches
HIVIC0805	2.00 ± 0.20	1.25 ± 0.10	0.50 ± 0.10	0.40 ± 0.20	0.40 ± 0.20	mm

This specification may be changed at any time without prior notice Please confirm technical specifications before you order and/or use.

HMC Series High Value Thick Film Chip Resistor

Stackpole Electronics, Inc.

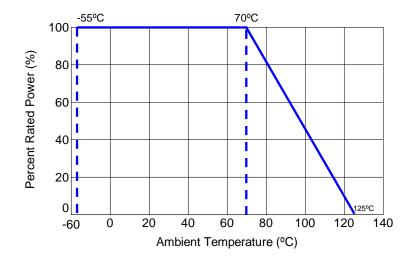
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	Mechanical Specifications (cont.)							
Type/Code	L Body Length	W Body Width	H Body Height	a Top Termination	b Bottom Termination	Unit		
HMC1206	0.122 ± 0.006	0.061 ± 0.004	0.022 ± 0.006	0.020 ± 0.010	0.020 ± 0.008	inches		
	3.10 ± 0.15	1.55 ± 0.10	0.55 ± 0.15	0.50 ± 0.25	0.50 ± 0.20	mm		
HMC1210	0.126 ± 0.008	0.102 ± 0.006	0.022 ± 0.004	0.020 ± 0.008	0.020 ± 0.008	inches		
	3.20 ± 0.20	2.60 ± 0.15	0.55 ± 0.10	0.50 ± 0.20	0.50 ± 0.20	mm		
HMC2010	0.197 ± 0.008	0.098 ± 0.006	0.022 ± 0.004	0.024 ± 0.010	0.020 ± 0.008	inches		
	5.00 ± 0.20	2.50 ± 0.15	0.55 ± 0.10	0.60 ± 0.25	0.50 ± 0.20	mm		
HMC2512	0.250 ± 0.008	0.126 ± 0.006	0.022 ± 0.004	0.024 ± 0.010	0.020 ± 0.008	inches		
	6.35 ± 0.20	3.20 ± 0.15	0.55 ± 0.10	0.60 ± 0.25	0.50 ± 0.20	mm		

Performance Characteristics					
Test Test Condition (JIS C 5202) Test Result					
Long Term Stability	Nominal temperature & humidity for 1000 hours	± 0.5%			
High Temperature Loading	15 VDC, 1.5 hour ON, 0.5 hour OFF, 1000 hours 70°C	± 3%			
Resistance to Solder Heat	260°C ± 5°C, 10 seconds +1/-0	± 1%			
Short Time Overload	5 seconds at maximum overload voltage	± 2%			
Voltage Coefficient of Resistance	Per JIS C 5202	± 0.5%/V			

Operating temperature range is -55°C to +125°C

Power Derating Curve:



High Value Thick Film Chip Resistor

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	Recomme	nded Pad Layouts					
Type/Code	A	B	С	Unit			
HMC0402	0.020	0.018	0.024	inches			
	0.50	0.45	0.60	mm			
HMC0603	0.035	0.024	0.035	inches			
	0.90	0.60	0.90	mm			
HMC0805	0.047	0.028	0.051	inches			
	1.20	0.70	1.30	mm			
HMC1206	0.079	0.035	0.063	inches			
	2.00	0.90	1.60	mm			
HMC1210	0.079	0.035	0.110	inches			
	2.00	0.90	2.80	mm			
HMC2010	0.150	0.035	0.110	inches			
	3.80	0.90	2.80	mm			
HMC2512	0.193	0.063	0.138	inches			
	4.90	1.60	3.50	mm			

Recommended Solder Profile

This information is intended as a reference for solder profiles for Stackpole resistive components. These profiles should be compatible with most soldering processes. These are only recommendations. Actual numbers will depend on board density, geometry, packages used, etc., especially those cells labeled with "*".

100% Matte Tin / RoHS Compliant Terminations

Soldering iron recommended temperatures: 330°C to 350°C with minimum duration. Maximum number of reflow cycles: 3.

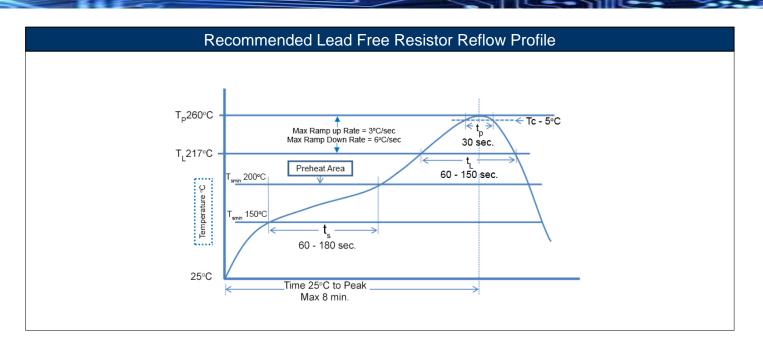
Wave Soldering							
Description	Description Maximum Recommended Minimum						
Preheat Time	80 seconds	70 seconds	60 seconds				
Temperature Diff.	140°C	120°C	100°C				
Solder Temp.	260°C	250°C	240°C				
Dwell Time at Max.	10 seconds	5 seconds	*				
Ramp DN (°C/sec)	N/A	N/A	N/A				

Temperature Diff. = Defference between final preheat stage and soldering stage.

Convection IR Reflow						
Description Maximum Recommended Minimum						
Ramp Up (°C/sec)	3°C/sec	2°C/sec	*			
Dwell Time > 217°C	150 seconds	90 seconds	60 seconds			
Solder Temp.	260°C	245°C	*			
Dwell Time at Max.	30 seconds	15 seconds	10 seconds			
Ramp DN (°C/sec)	6°C/sec	3°C/sec	*			

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High Value Thick Film Chip Resistor



RoHS Compliance

Stackpole Electronics has joined the worldwide effort to reduce the amount of lead in electronic components and to meet the various regulatory requirements now prevalent, such as the European Union's directive regarding "Restrictions on Hazardous Substances" (RoHS 3). As part of this ongoing program, we periodically update this document with the status regarding the availability of our compliant components. All our standard part numbers are compliant to EU Directive 2011/65/EU of the European Parliament as amended by Directive (EU) 2015/863/EU as regards the list of restricted substances.

RoHS Compliance Status								
Standard Product Series	Description	Package / Termination Type	Standard Series RoHS Compliant	Lead-Free Termination Composition	Lead-Free Mfg. Effective Date (Std Product Series)	Lead-Free Effective Date Code (YY/WW)		
НМС	High Value Thick Film Surface Mount Chip Resistor	SMD	YES(1)	100% Matte Sn over Ni	Jan-04	04/01		

Note (1): RoHS Compliant by means of exemption 7c-I.

"Conflict Metals" Commitment

We at Stackpole Electronics, Inc. are joined with our industry in opposing the use of metals mined in the "conflict region" of the eastern Democratic Republic of the Congo (DRC) in our products. Recognizing that the supply chain for metals used in the electronics industry is very complex, we work closely with our own suppliers to verify to the extent possible that the materials and products we supply do not contain metals sourced from this conflict region. As such, we are in compliance with the requirements of Dodd-Frank Act regarding Conflict Minerals.

Compliance to "REACH"

We certify that all passive components supplied by Stackpole Electronics, Inc. are SVHC (Substances of Very High Concern) free and compliant with the requirements of EU Directive 1907/2006/EC, "The Registration, Evaluation, Authorization and Restriction of Chemicals", otherwise referred to as REACH. Contact us for complete list of REACH Substance Candidate List.

Resistive Product Solutions

Environmental Policy

It is the policy of Stackpole Electronics, Inc. (SEI) to protect the environment in all localities in which we operate. We continually strive to improve our effect on the environment. We observe all applicable laws and regulations regarding the protection of our environment and all requests related to the environment to which we have agreed. We are committed to the prevention of all forms of pollution.

